

41. (Amended) A process for the production of a wiring board as claimed in claim 37, wherein:

92 a step for forming said conductive member is effected by forming a nickel (Ni) plating in accordance with electroless plating method.

42. (Amended) A process for the production of a wiring board as claimed in claim 38, wherein:

a step for forming said conductive member is effected by forming a nickel (Ni) plating in accordance with electroless plating method.

REMARKS

Applicants respectfully request that the foregoing amendments be made prior to examination of the present application.

Respectfully submitted,

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By Pat Schwab 25,479

FOLEY & LARDNER  
Customer Number: 22428

for Glenn Law  
Attorney for Applicant  
Registration No. 34,371



22428

PATENT TRADEMARK OFFICE

Telephone: (202) 672-5426

Facsimile: (202) 672-5399